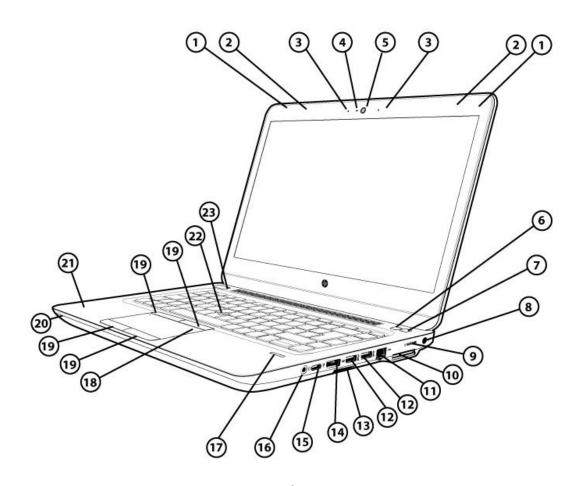
Overview

HP ProBook 640 G2 Notebook PC



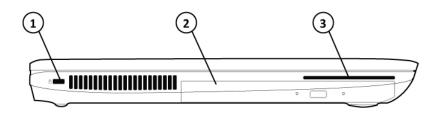
Front/Right

- 1. WLAN antennas (2)
- 2. WWAN antennas (2) (select models)
- 3. Internal microphones (2)
- 4. Webcam LED (select models)
- 5. Webcam (select models)
- 6. Wireless on/off button
- 7. Speaker mute button
- 8. Power connector
- 9. SIM card slot
- 10. Docking connector
- 11. Ethernet port
- 12. USB 3.0 ports (2)

- 13. SD card slot
- 14. Display port
- 15. USB-C[™] port
- 16. Microphone/ headphones combo jack
- 17. Fingerprint reader (select models)
- 18. Touchpad
- 19. Touchpad buttons (4)
- 20. Indicator LEDs: Wireless Light, Power Light, AC Adapter/Battery Light, Storage Usage Light
- 21. NFC (select models)
- 22. Pointstick
- 23. Power button



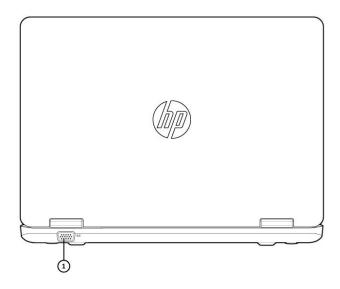
Overview



Left

Security lock slot
 Optical drive

3. Smart Card Reader



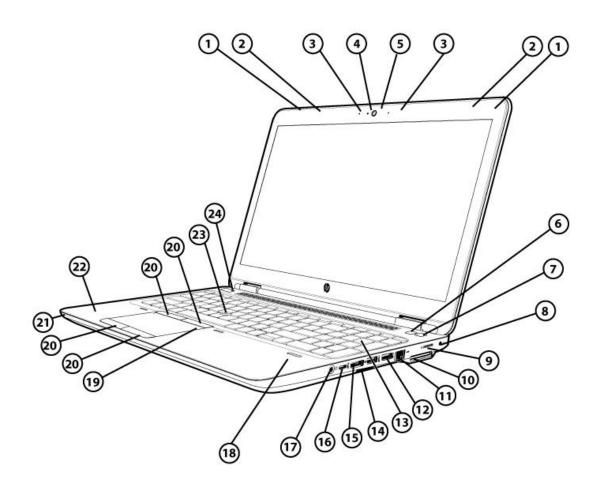
Back

1. VGA port



Overview

HP ProBook 650 G2 Notebook PC



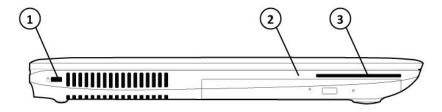
Front/Right

- 1. WLAN antennas (2)
- 2. WWAN antennas (2) (select models)
- 3. Internal microphones (2)
- 4. Webcam LED (select models)
- 5. Webcam (select models)
- 6. Wireless on/off button
- 7. Speaker mute button
- 8. Power connector
- 9. SIM card slot
- 10. Docking connector
- 11. Ethernet port
- 12. USB 3.0 ports (2)

- 13. Numeric keypad
- 14. SD card slot
- 15. Display port
- 16. USB-C[™] port
- 17. Microphone/ headphones combo jack
- 18. Fingerprint reader (select models)
- 19. Touchpad
- 20. Touchpad buttons (4)
- 21. Indicator LEDs: Wireless Light, Power Light, AC Adapter/Battery Light, Storage Usage Light
- 22. NFC (select models)
- 23. Pointstick
- 24. Power button



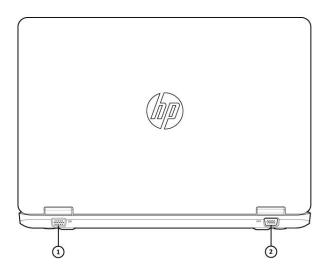
Overview



Left

- 1. Security lock slot
- 2. Optical drive

3. Smart card reader



1. VGA port

Back

2. Serial port optional (650 only)



Overview

AT A GLANCE

- Windows 10 versions, Windows 8.1 versions, Windows 7 versions, NeoKylin Linux 64, FreeDOS 2.0
- Choice of 6th Generation Intel® Core™ processors
- Thin and light design—PC-ABS (Polycarbonate—Acrylnitrile/Butadiene/Styrene) durable material is nearly 20% thinner; soft-touch, more durable 4-step paint process; larger buttons (power), revamped keyboard (arrow keys); latch/hook removal for clean palmrest design; top mounted speakers for optimized audio experience (compared to previous generation)
- The HP Premium keyboard is spill-resistant and offered with optional backlit design
- Large Touchpad with gestures support, on/off button with LED indicator
- Enhanced security features including TPM1.2/2.02, SmartCard Reader, HP Biosphere, HP Client Security, Self-Encrypting storage drives, and optional Fingerprint reader
- LED-backlit display
 - HP ProBook 640: 14.0" diagonal HD and FHD or Touch FHD with camera and with WWAN HP ProBook 650: 15.6" diagonal HD and FHD or Touch FHD with camera and with WWAN
- Optional HD webcam with dual-microphone array for video conferencing
- DisplayPort 1.2 now native with integrated graphics
- Three USB 3.0 ports for fast data transfer from devices: 1 standard, 1 charging, and one USB-C™ charging port
- HD Audio with DTS Sound+™ optimized for high fidelity audio
- Wireless and speaker mute button to conveniently manage the connectivity and speaker.
- Flexible wireless connectivity options:
 - Broadband Wireless (WWAN)
 - Wireless LAN (WLAN)
 - Personal area network (WPAN Bluetooth®)
 - Near Field Communication (NFC)
- Choice of hard drives up to 1 TB or solid state drives up to 512 GB
- Passed MIL STD testing¹

1. MIL STD 810G testing is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Damage under the MIL STD test conditions or any accidental damage requires an optional HP Accidental Damage Protection Care Pack.

2. This product ships with TPM 1.2 with option to upgrade to TPM 2.0. Upgrade utility is expected to be available by the second half of 2016 via HP Customer Support.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Technical Specifications

PRODUCT NAMES

HP ProBook 640 G2 Notebook PC

HP ProBook 650 G2 Notebook PC

OPERATING SYSTEM

Preinstalled

Windows 10 Pro 64¹

Windows 10 Home 641

Windows 10 Home Single Language 641

Windows 10 Home64 (National Academic only)¹ Windows 10 Pro 64 (National Academic only)¹

Windows 8.1 Pro 643

Windows 8.1 Pro 64 (National Academic only)3

Windows 8.1 643

Windows 7 Professional 64 (Available through downgrade rights from Windows 10 Pro 64)² Windows 7 Professional 32 (Available through downgrade rights from Windows 10 Pro 64)² Windows 7 Professional 32 (Available through downgrade rights from Windows 10 Pro 64)

(National Academic only)2

Windows 7 Professional 64 (Available through downgrade rights from Windows 10 Pro 64)

(National Academic only)² Windows 7 Professional 64³ Windows 7 Professional 32³

Windows 7 Professional 32 (National Academic only)³ Windows 7 Professional 64 (National Academic only)³

NeoKylin Linux 64 FreeDOS 2.0

Web-only Support

Windows 10 Enterprise 64¹ Windows 8.1 Enterprise 64¹ Windows 7 Enterprise 64¹ Windows 7 Enterprise 32¹

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://http://www.microsoft.com.
- 2. This system is preinstalled with Windows 7 Professional software and also comes with a license and media for Windows 10 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data
- Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately
 purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. See
 http://http://www.microsoft.com.



Technical Specifications

PROCESSORS

ProBook 640 G2

Intel® Core™ i7-6600U with Intel® HD Graphics 520

(2.6 GHz, up to 3.4 GHz with Intel® Turbo Boost Technology, 4 MB cache, 2 cores)^{1,2} – Integrated with Chipset

Intel® Core™ i5-6300U with Intel® HD Graphics 520

(2.4 GHz, up to 3 GHz with Intel® Turbo Boost Technology, 3 MB cache, 2 cores) 1,2 – Integrated with Chipset

Intel® Core™ i5-6200U with Intel® HD Graphics 520

(2.3 GHz, up to 2.8 GHz with Intel® Turbo Boost Technology, 3 MB cache, 2 cores) 1,2 – Integrated with Chipset

Intel® Core™ i3-6100U with Intel® HD Graphics 520

(2.3 GHz, 3 MB cache, 2 cores) 1,2 - Integrated with Chipset

ProBook 650 G2

Intel® Core™ i7-6820HQ with Intel® HD Graphics 530

(2.7 GHz, up to 3.6 GHz with Intel® Turbo Boost Technology, 8 MB cache, 4 cores) 1,2 – QM170 Chipset

Intel® Core™ i5-6440HQ with Intel® HD Graphics 530

(2.6 GHz, up to 3.5 GHz with Intel® Turbo Boost Technology, 6 MB cache, 4 cores) 1,2 – QM170 Chipset

Intel® Core™ i7-6600U with Intel® HD Graphics 520

(2.6 GHz, up to 3.4 GHz with Intel® Turbo Boost Technology, 4 MB cache, 2 cores) 1,2 – Integrated with Chipset

Intel® Core™ i5-6300U with Intel® HD Graphics 520

(2.4 GHz, up to 3 GHz with Intel® Turbo Boost Technology, 3 MB cache, 2 cores) 1,2 – Integrated with Chipset

Intel® Core™ i5-6200U with Intel® HD Graphics 520

(2.3 GHz, up to 2.8 GHz with Intel® Turbo Boost Technology, 3 MB cache, 2 cores) 1,2 — Integrated with Chipset

Intel® Core™ i3-6100U with Intel® HD Graphics 520

(2.3 GHz, 3 MB cache, 2 cores) 1,2 - Integrated with Chipset

- 1. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering is not a measurement of higher performance.
- 2. Some vPro™ functionality, such as Intel® Active management technology and Intel Virtualization technology, requires additional 3rd party software in order to run. Availability of future "virtual appliances" applications for Intel vPro technology is dependent on 3rd party software providers. Microsoft Windows required.

NOTE: Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.

CHIPSET

Integrated with processor or QM170



Technical Specifications

GRAPHICS

HP ProBook 640

Integrated:

Intel® HD1 Graphics 520

Discrete:

AMD Radeon™ R7 M365X (2 GB GDDR5 dedicated)²

HP ProBook 650

Integrated:

Intel® HD¹ Graphics 520 Intel® HD¹ Graphics 530

Discrete:

AMD Radeon™ R7 M365X (2 GB GDDR5 dedicated)²

- 1. HD content required to view HD images.
- 2. AMD Dynamic Switchable Graphics technology requires an Intel processor, plus an AMD Radeon™ discrete graphics configuration and is not available on FreeDOS and Linux OS. With AMD Dynamic Switchable Graphics technology, full enablement of all discrete graphics video and display features may not be supported on all systems (e.g. OpenGL applications will run on the integrated GPU or the APU as the case may be). Planned to be available in February 2016.

DISPLAY

HP ProBook 640

Internal

Non-Touch

14.0" diagonal LED backlight HD1 Anti-glare 45% CG 220 nits (1366x768)

14.0" diagonal LED backlight HD1 Anti-glare 45% CG 220 nits (1366x768) with camera

14.0" diagonal LED backlight HD1 Anti-glare 45% CG 220 nits (1366x768) with WWAN

14.0" diagonal LED backlight HD1 Anti-glare 45% CG 220 nits (1366x768) with camera and with WWAN

14.0" diagonal LED backlight FHD Anti-glare 60% CG 300 nits (1920x1080)

14.0" diagonal LED backlight FHD Anti-glare 60% CG 300 nits (1920x1080) with camera

14.0" diagonal LED backlight FHD Anti-glare 60% CG 300 nits (1920x1080) with WWAN

14.0" diagonal LED backlight FHD Anti-glare 60% CG 300 nits (1920x1080) with camera & WWAN

Touch

14.0" diagonal LED backlight FHD 60% CG 300 nits (1920x1080) with camera and with WWAN

External

Up to 32-bit per pixel color depth

VGA

Port supports resolutions up to 1920 x 1200 external resolution @60 Hz

DisplayPort 1.2

Supports resolutions up to 2560 \times 1600, 30-bit color depth at 60 Hz, and full HD (1920 \times 1080) monitors, 24-bit color depth at 120 Hz

Number of Displays Supported

Number of Displays with Optional ² HP UltraSlim Docking Station	UMA	Discrete	
ProBook 640	3	5	



Technical Specifications

HP ProBook 650

Internal

Non-Touch

15.6" diagonal LED backlight HD¹ Anti-glare 45% CG 220 nits (1366 x 768)

15.6" diagonal LED backlight HD1 Anti-glare 45% CG 220 nits (1366 x 768) with camera

15.6" diagonal LED backlight HD1 Anti-glare 45% CG 220 nits (1366 x 768) with WWAN

15.6" diagonal LED backlight HD1 Anti-glare 45% CG 220 nits (1366 x 768) with camera and with WWAN

15.6" diagonal LED backlight FHD Anti-glare 60% CG 300 nits (1920 x 1080)

15.6" diagonal LED backlight FHD Anti-glare 60% CG 300 nits (1920 x 1080) with camera

15.6" diagonal LED backlight FHD Anti-glare 60% CG 300 nits (1920 x 1080) with WWAN

15.6" diagonal LED backlight FHD Anti-glare 60% CG 300 nits (1920 x 1080) with camera & WWAN

Touch

15.6" diagonal LED backlight FHD 60% CG 300 nits (1920 x 1080) with camera with WWAN

External

Up to 32-bit per pixel color depth

VGA

Port supports resolutions up to 1920 x 1200 external resolution @60 Hz

DisplayPort 1.2

Supports resolutions up to 2560 x 1600, 30-bit color depth at 60 Hz, and full HD (1920 x 1080) monitors, 24-bit color depth at $120 \, \text{Hz}$

Number of Displays Supported

Number of Displays with Optional ² HP UltraSlim Docking Station	UMA	Discrete
ProBook 650	3	5

- 1. HD content required to view HD images.
- 2. Sold separately or as an optional feature.

NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.

STORAGE AND DRIVES

Primary Storage Bay

Hard Drives¹

Supports SATA3, 7 mm

2.5" Hard Drives1

500 GB 7200 rpm 500 GB 7200 rpm Self-Encrypting Drive (Opal 2) 500 GB 7200 rpm Self Encrypting Drive (Opal 2) (FIPS) 1 TB 5400 rpm 500 GB Hybrid

2.5" Solid State Drive1

128 GB SATA TLC (Brazil only)



Technical Specifications

256 GB SATA TLC (Brazil only)

M.2 (NGFF) Solid State Drive¹

128 GB SATA-3 TLC 180 GB SATA-3 MLC 180 GB SATA-3 MLC (Opal 2) 240 GB SATA-3 MLC 256 GB PCIe-3x4 DS NVMe 256 GB SATA-3 MLC (Opal 2) 256 GB SATA-3 TLC 512 GB SATA-3 TLC

For hard drives and solid state drives, GB = 1 billion bytes. Actual formatted capacity is less. Up to 16 GB (for Windows 7) and up to 30 GB (for Windows 8 and 10) of system disk is reserved for the system recovery software.

OPTICAL DRIVES

Fixed 9.5 mm SATA

DVD-ROM Drive DVD+/-RW SuperMulti DL¹ Blu-ray ROM DVD+/-RW SuperMulti DL¹ Weight saver²

1. For Blu-ray drives, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require an HDMI digital connection and your display may require HDCP support. HD-DVD disks cannot be played on this drive. Note that DVD-RAM cannot read or write to 2.6 GB Single Sided/5.2 GB Double Sided — Version 1.0 media. Actual speeds may vary. Don't copy copyright-protected materials. Double Layer discs can store more data than single layer discs; discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

2. Not available on with Touch panel.

MEMORY

Standard

DDR4-2133 SDRAM (Transfer rates up to 2133 MT/s) Two SODIMM slots supporting dual-channel memory

4096 MB Total System Memory (4096 MB x 1) 8192 MB Total System Memory (4096 MB x 2)

8192 MB Total System Memory (8192 MB x 1)

16384 MB Total System Memory (8192 MB x 2)

Maximum

Up to 16384 MB with optional 8192 MB SODIMMs in slots 1 and 2

Dual-channel



Technical Specifications

Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory slots.

NOTE: Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

Intel® Pro Wireless Display (WiDi Pro)¹

1. Integrated Intel Wi-Di software is available on select models only and requires separately purchased projector, tv or computer monitor with an integrated or external Wi-Di receiver. External Wi-Di receivers connect to the projector, tv or computer monitor via a standard VGA, HDMI cable, also sold separately.

Broadband Wireless (WWAN) 2,3

HP lt4120 Qualcomm® Snapdragon™ X5 LTE Mobile Broadband Module HP hs3110 HSPA+ Mobile Broadband Module

Wireless LAN (WLAN)^{1,2}

Options via Minicard Intel® 802.11a/b/g/n/ac (2x2) and Bluetooth® 4.2 Combo Intel® 802.11a/b/g/n/ac (2x2) and Bluetooth® 4.0 Combo Broadcom 802.11a/b/g/n (2x2) and Bluetooth® 4.0 Combo Broadcom 802.11b/g/n (1x1) WiFi and Bluetooth® 4.0 Combo Realtek 802.11b/g/n (1x1) Wi-Fi

Personal area network (WPAN Bluetooth) 1,2

Bluetooth® 4.0 supported via all combo cards (except for Intel® 802.11 ac Non-vPro) Bluetooth® 4.1 supported via (Intel® 802.11 ac Non-vPro only)

Near Field Communication (NFC) Optional²

HP Module with NXP NFC Controller NPC100

Support for Miracast (Windows 8.1 and Windows 10) Intel® Pro Wireless Display (WiDi Pro)

- 1. Wireless access point and Internet service is required and is not included. Availability of public wireless access points limited.
- 2. Sold separately or as an optional feature.
- 3. WWAN module is optional and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

Communications¹

Intel® I219LM 10/100/1000 Ethernet Intel® I219V 10/100/1000 Ethernet

1. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.



Technical Specifications

AUDIO/MULTIMEDIA

Audio

HD Audio with DTS Sound+™

(2) Integrated stereo speakers
Integrated digital microphone (Dual-microphone array when equipped with optional webcam)
Function keys for microphone mute, volume up, volume down
Stereo headphone/line out
Stereo microphone in

Webcam

Optional 720p HD webcam 1,2

- HD format (widescreen)
- Supports videoconferencing (non-HD) and still image capture
- High quality fixed focus lens
- Video capture at various resolutions up to 1280x720 resolution (720p) and up to 30fps
- M-JPEG compression supports higher frame rates for video capture and videoconferencing
- Improved low light sensitivity
- Improved dynamic range
- Skype-ready (subscription required and sold separately)
- Sold separately or as an optional feature.
- 2. HD content required to view HD images.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

HP Premium Keyboard

The HP spill-resistant keyboard is designed using a thin layer of Mylar film under the keyboard. The 101/102-key compatible keyboard features a full-pitch key layout with desktop keyboard features, such as editing keys, both left and right control and alt keys, and function keys. DuraKeys only available with Backlit option.

Three Keyboard options:

Touchpad, Spill-resistant with drain Touchpad, Spill-resistant with drain, DuraKeys & Backlit Dual Point, Spill-resistant with drain, DuraKeys & Backlit

Touchpad

On/Off button
Enabled by default
2F Scrolling – On
2F Zoom (Pinch) – On
OSD (enable / disable) – On
Win 8 2F tap = right click – On
Win 8 Edge Swipes – On

Buttons and Function Keys

F1 – Sleep F2 – Blank



Technical Specifications

F3 - Backlit

F4 - Display Switch

F5 - Brightness down

F6 - Brightness up

F7 - Blank

F8 - Volume down

F9 - Volume up

F10 - Mic Mute

F11 - Bank

F12 - Num lock

SOFTWARE AND SECURITY

Preinstalled Software with Windows Operating System BIOS

HP BIOSphere1

HP DriveLock | HP Automatic DriveLock

HP BIOS Protection²

BIOS Update via Network

Master Boot Record Security

Power On Authentication

Pre-Boot Security

Secure Erase³

Hybrid Boot

Measure Boot

Secure Boot

Absolute Persistence Module⁴

Pre-boot Authentication

Multi Media

Cyberlink Power DVD, BD

Cyberlink Power2Go (Secure Burn)

Cyberlink YouCam BE (Windows 7 only)

Communication

HP GPS and Location (Windows 7 only)5

HP Connection Manager with support for HP Mobile Connect (Windows 7 only)⁶

HP Mobile Connect Pro (Windows 8.1 and Windows 10 only)⁶

Intel® Wireless Display (WiDi) Software for Windows7

Native Miracast Support⁸

HP Value Add Software

HP 3D DriveGuard (requires Windows)

HP ePrint Driver9



Technical Specifications

HP Hotkey

HP Recovery Manager

HP Recovery Disc Creator

HP Registration App (Windows 8.1 only)

HP Support Assistant

HP Noise Reduction Software

3rd Party

Foxit PhantomPDF Express for HP

Microsoft Products

Buy Office

Bing Search

Skype¹⁰

Manageability

HP Driver Packs¹¹

HP SoftPaq Download Manager (SDM)

HP System Software Manager (SSM)11

HP BIOS Config Utility (BCU)11

HP Client Catalog¹¹

HP CIK for Microsoft SCCM¹¹

LANDESK Management¹²

For more information on HP Client Management Solutions refer to: http://www.hp.com/go/clientmanagement.

Client Security Software

HP Client Security

- HP Security Manager (including Credential Manager and Password Manager)
- HP Drive Lock
- HP Fingerprint Sensor
- HP Password Manager
- Absolute Persistence Module
- Power On Authentication

Microsoft Security Essentials13

Microsoft Defender

Security

Trusted Platform Module (TPM) 1.2 (Infineon SLB9670). Common Criteria EAL4+ Certified.

Upgradable to TPM 2.0. Convertible to FIPS 140-2 Certified mode. (TPM 2.0 is not available for Win 7 32-bit.)¹⁴

HP Fingerprint reader

Security lock slot

Integrated Smart Card Reader

For more information on HP Client Security Software Suite, refer to http://www.hp.com/go/clientsecurity.



Technical Specifications

- 1. Available only on business PCs with HP BIOS.
- 2. May require a manual recovery step if all copies of BIOS are compromised or deleted
- 3. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88.
- 4. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: http://www.absolute.com/company/legal/agreements/ computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.
- 5. GPS access requires an unobstructed path to multiple satellites. Performance may be affected if/when used inside of buildings, bridges or heavily congested metropolitan areas. Requires separately purchased GPS navigation software available from multiple GPS applications.
- 6. HP Mobile Connect Pro is only available on preconfigured devices with WWAN. For geographic availability refer to http://www.hp.com/go/mobileconnect
- 7. Integrated Intel Wi-Di feature is available on select configurations only and requires separately purchased projector, TV or computer monitor with an integrated or external Wi-Di receiver. External Wi-Di receivers connect to the projector, TV or computer monitor via a standard HDMI cable, also sold separately.
- 8. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming media players that also support Miracast. You can use Miracast to share what you're doing on your PC and present a slide show. For more information: http://windows.microsoft.com/en-us/windows-8/project-wireless-screen-miracast
- 9. Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see http://www.hp.com/go/eprintcenter). Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary.
- 10. Skype is not offered in China.
- 11. Not preinstalled, however available for download at http://www.hp.com/go/clientmanagement
- 12. Subscription required.
- 13. Opt in and internet connection required for updates.
- 14. This product ships with TPM 1.2 with option to upgrade to TPM 2.0. Upgrade utility is expected to be available by the second half of 2016 via HP Customer Support.

POWER

Power Supply

HP 45W Smart AC Adapter (UMA only)

HP 45W Smart AC Adapter (Only available for Japan and England)

HP 65W Smart AC Adapter

HP 65W Smart EM Adapter (only available for Asia, China and India)

Power cord included is 1.8 m (+/-0.1 m) or 1.0 m (+/-0.1 m).

Primary Battery

HP 3-cell Long Life Prismatic (48 WHr)

Battery Life¹

HP ProBook 640 Notebook PC	UMA Graphics	Discrete Graphics



Technical Specifications

3-cell (48 Whr) with SSD	Up to 12 hrs 30 mins	Up to 12 hrs 15 mins
3-cell (48 Whr) with HDD	Up to 10 hrs	Up to 9 hrs 45 mins
HP ProBook 650 Notebook PC	UMA Graphics	Discrete Graphics
3-cell (48 Whr) with SSD	Up to 12 hrs 30 mins	Up to 12 hrs 15 mins
3-cell (48 Whr) with HDD	Up to 9 hrs 45 mins	Up to 9 hrs 45 mins

System Standby Time²

	UMA Graphics	Discrete Graphics
HP ProBook 640 Notebook PC	Up to 249 hrs	Up to 190 hrs
HP ProBook 650 Notebook PC	Up to 249 hrs	Up to 190 hrs

Battery recharge times

	ProBook 640 G2	ProBook 650 G2
Time to 90 ³ % Charge (minutes)	113	113
Time to 1004% Charge (minutes)	163	163

- 1. Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.
- 2. Standby life will vary depending on various factors including battery, Memory, CPU, EC and LAN chip. The maximum capacity of the battery will naturally decrease with time and usage.
- 3. Recharges your battery up to 90% within 113 minutes when the system is off. Applies to 3-cell 48Whr battery only. When the PC is powered on, charge time may increase and will vary based on the workload of the notebook PC.
- 4. Recharges your battery up to 100% within 163 minutes when the system is off. Applies to 3-cell 48Whr battery only. When the PC is powered on, charge time may increase and will vary based on the workload of the notebook PC.

WEIGHTS & DIMENSIONS

HP ProBook 640 Notebook PC Weight

Starting at 4.30 lbs (1.95 kg)1

(3-cell battery, ODD weight saver, UMA, no FPR, 1 SODIMM, WLAN only, SSD, touchpad only, no camera, no WWAN)



Technical Specifications

Dimensions (w x d x h)

13.39 x 9.33 x 1.06 in (Front and rear)² 34.0 x 23.7 x 2.70 cm (Front and rear)²

HP ProBook 650 Notebook PC Weight

Starting at 5.10 lbs (2.31 kg)1

(3-cell battery, ODD weight saver, UMA, no FPR, 1 SODIMM, WLAN only, SSD, touchpad only, no camera, no WWAN)

Dimensions (w x d x h)

 $14.88 \times 10.11 \times 27.40 \text{ in}$) (Front and rear)² $37.8 \times 25.70 \times 2.74 \text{ cm}$) (Front and rear)²

- 1. Weight varies by configuration and components.
- 2. Height varies depending upon where on the notebook the measurement is made.

PORTS/SLOTS

Ports

USB Type-C™ - One
USB 3.0 port - One
USB 3.0 port charging - One
RJ-45 / Ethernet - One
Docking connector - One
Headphone / Microphone (Combo jack) - One
AC port (4.5mm) - One
DisplayPort 1.2 -One
VGA port - One
Serial port optional - One (only available on HP ProBook 650)¹

1. Sold separately or as an optional feature.

SD Media Reader Slot

Supports SD, SDHC, SDXC

SERVICE AND SUPPORT

Limited 3-year, 1-year or 90-day limited warranty options available, depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Optional 1 HP Care Pack Services 2 are extended service contracts which go beyond your standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at http://www.hp.com/go/cpc.

- 1. Sold separately or as an optional feature.
- 2. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. Consult the HP Customer Support Center for details. http://h20000.www2.hp.com/bizsupport/TechSupport/ProductRoot.jsp



HP ProBook 640 G2 Notebook PC HP ProBook 650 G2 Notebook PC

QuickSpecs

Technical Specifications



Technical Specifications

SYSTEM UNIT

TBD

DISPLAYS*

14.0 FHD AG WLED SVA 60%cg 300nits eDP Slim

Panel

Active Area (W x H) 309.40 x 173.95 (mm)

Dimensions (W x H) 320.9 x 205.6 (mm) max

Diagonal Size 14 (inch)

Thickness 3.0 (mm) max

Weight 270 g max

Interface eDP 1.2

Surface Treatment Anti-Glare (AG)

Contrast Ratio 300:1 (typical)

Refresh Rate 60 Hz

Brightness 300 nits

Pixel Resolution - Format 1920 x 1080 (FHD)

PPI 157

Pixel Resolution - Configuration RGB

Backlight LED

Color Gamut Coverage 60%

Color Depth 6 bits

Viewing Angle SVA 45/45/25/35



Technical Specifications

14.0 HD AG WLED SVA 45%cg 220nits eDP Flat

Panel

Active Area (W x H) 309.40 x 173.95 (mm)

Dimensions (W x H) 320.9 x 205.6 (mm) max

Diagonal Size 14 (inch)

Thickness 3.6 (mm) max

Weight 320 g max

Interface eDP 1.2

Surface Treatment Anti-Glare (AG)

Contrast Ratio 300:1 (typical)

Refresh Rate 60 Hz

Brightness 220 nits

Pixel Resolution - Format 1280 x 768 (HD)

PPI 112

Pixel Resolution - Configuration RGB

Backlight LED

Color Gamut Coverage 45%

Color Depth 6 bits + Hi FRC

Viewing Angle SVA 45/45/25/35



Technical Specifications

Panel

Active Area (W x H) 309.40 x 173.95 (mm)

Dimensions (W x H) 320.9 x 205.6 (mm) max

Diagonal Size 14 (inch)

Thickness 3.0 (mm) max

Weight 270 g max

Interface eDP 1.2

Contrast Ratio 300:1 (typical)

Refresh Rate 60 Hz

Brightness 300 nits

Pixel Resolution - Format 1920 x 1080 (FHD)

PPI 157

Pixel Resolution - Configuration RGB

Backlight LED

Color Gamut Coverage 60%

Color Depth 6 bits

Viewing Angle SVA 45/45/25/35

Touch Enabled Optional

Touch Point Supported 10-point multi-touch

Other Features AS

Pen Enabled No

15.6 FHD AG WLED SVA 60%cg 300nits eDP Slim 3.2mm



Technical Specifications

Panel

Active Area (W x H) 344.2 x 193.5 (mm)

Dimensions (W x H) 360 x 224.3 (mm) max

Diagonal Size 15.6 (inch)

Thickness 3.2 (mm) max

Weight 360 g max

Interface eDP 1.2

Surface Treatment Anti-Glare (AG)

Contrast Ratio 400:1 (typical)

Refresh Rate 60 Hz

Brightness 300 nits

Pixel Resolution - Format 1920 x 1080 (FHD)

PPI 142

Pixel Resolution - Configuration RGB

Backlight LED

Color Gamut Coverage 60%

Color Depth 6 bits

Viewing Angle SVA 45/45/25/35

15.6 HD AG WLED SVA 45%cg 220nits eDP Flat



Technical Specifications

Panel

Active Area (W x H) 344.2 x 193.5 (mm)

Dimensions (W x H) 360 x 224.3 (mm) max

Diagonal Size 15.6 (inch)

Thickness 3.8 (mm) max

Weight 420 g max

Interface eDP 1.2

Surface Treatment Anti-Glare (AG)

Contrast Ratio 300:1 (typical)

Refresh Rate 60 Hz

Brightness 220 nits

Pixel Resolution - Format 1280 x 768 (HD)

PPI 101

Pixel Resolution - Configuration RGB

Backlight LED

Color Gamut Coverage 45%

Color Depth 6 bits + Hi FRC

Viewing Angle SVA 45/45/25/35

15.6 FHD WLED SVA 60%cg 300nits eDP Slim 3.2mm Touch



Technical Specifications

Panel

Active Area (W x H) 344.2 x 193.5 (mm)

Dimensions (W x H) 360 x 224.3 (mm) max

Diagonal Size 15.6 (inch)

Thickness 3.2 (mm) max

Weight 360 g max

Interface eDP 1.2

Contrast Ratio 400:1 (typical)

Refresh Rate 60 Hz

Brightness 300 nits

Pixel Resolution - Format 1920 x 1080 (FHD)

PPI 142

Pixel Resolution - Configuration RGB

Backlight LED

Color Gamut Coverage 60%

Color Depth 6 bits

Viewing Angle SVA 45/45/25/35

Touch Enabled Optional

Touch Point Supported 10-point multi-touch

Other Features AS

Pen Enabled No

SECURITY



^{*} All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

Technical Specifications

HP Fingerprint Reader (optional)

Mobile Voltage Operation 3.0V-3.6V

Operating Temperature 14° – 167°F (-10° – 75°C)

Current Consumption

Image

36 mA peak

Low Latency Wait for

Finger

950 uA

Capture Rate 59000 lines/sec

ESD Resistance IEC 61000-4-2 4B (±15KV)

Detection Matrix 200*1 (plus another secondary line)

508 dpi

10*1 mm sensor area

Smart Card Reader

Smart card standard PC/SC 2.0 for Windows smart card standard

 Dimensions (L x W x H)
 0.41x 0.08 x 0.32 in (10.5 x 2 x 8.2 mm)

 Smart Card support
 ISO 7816 Class A and AB smart cards

Smart Card Interface Smart Card Interface with T = 0 and T = 1 support

Support I2C memory card, SLE4418, SLE4428, SLE4432, SLE4442, SLE4436, SLE5536, SLE6636, AT88SC1608, AT45D041 card and AT45DB041 card via

external EEPROM

Operating systems No driver is required for this device. Native support is provided by the operating

system.

Power Normal Mode With card present, before being suspended: 40.9 mA

Without card present, before being suspended: 33.16 mA After being suspended with smart card present: 380 μ A After being suspended without smart card present: 380 μ A

Power Saving Mode With card present, before being suspended: 40.6 mA

Without card present: 380 µA

After being suspended with smart card present: 380 µA

Features

Support single slot

Support T0, T1 protocol

 Support I2C memory card, SLE4418, SLE4428, SLE4432, SLE4442, SLE4436.

 SLE5536, SLE6636, AT88SC1608, AT45D041 card and AT45DB041 card via external EEPROM

Support ISO7816 Class A, B and C (5V/3V/1.8V) card

 Implemented as an USB full speed device with bulk transfer endpoint, Mass

Storage endpoint

Built-in PLL for USB and Smart Card clocks requirement

 Support EEPROM for USB descriptors customization (PID/VID/ iManufacturer/iProduct/Serial Number), Direct Web Page Link, and accessing memory card module.



Technical Specifications

- EEPROM programmable via USB interface
- Support software update for memory card module
- Support Direct Web Page Link via configuration in external EEPROM
- Support short APDU and extended APDU
- Compatible with Microsoft USB-CCID driver
- Support remote wake up through inserting card/removing card
- Support USB selective suspend
- Support Power Saving Mode (Using one pin to select between Normal/PWR Saving Mode)
- Support card power over current protection mechanism
- Built in resonator.
- Support USB LPM (Link Power Management) features.
- Embedded clock source.

NETWORKING/COMMUNICATIONS

HP lt4120 Qualcomm® Snapdragon™ X5 LTE Mobile Broadband Module*

Technology/Operating bands LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3),

1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 17 lower),

800 (Band 20), 700 (Band 28).

HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4),

850 (Band 5), 900 (Band 8) MHz

EV-DO: 850 (BCO), 1900 (BC1) MHz (Only work with Verizon network) E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 (Band 5), 900 (Band 8)

MHz

Wireless protocol standards 3GPP Release 10 LTE Specification CAT.4, 20MHz BW

WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification

1xEVDO Release O, A and B.

E-GPRS: Class B, Multi-slot class 12, coding schemes CS1 - CS4

and MSC1 - MSC9

GPS Standalone, A-GPS (MS-A, MS-B and XTRA)

GPS bands 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz

Maximum data rates LTE: 150 Mbps (Download), 50 Mbps (Upload)

DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21 Mbps (Download), 5.76 Mbps (Upload)

CDMA 1xRTT: 153.6 kbps (Download), 153.6 kbps (Upload) EVDO Rel.A: 3.1 Mbps (Download), 1.8 Mbps (Upload) EVDO Rel.B: 14.7 Mbps (Download), 5.4Mbps (Upload) EDGE: 236.8 kbps (Download), 236.8 kbps (Upload) GPRS: 85.6 kbps(Download), 85.6 kbps (Upload)

Maximum output power LTE: 23 dBm

HSPA+: 23.5 dBm 1xRTT/EVDO: 24dBm E-GPRS 1900/1800: 26 dBm



Technical Specifications

E-GPRS 900/850: 27 dBm GPRS 1900/1800: 29.5 dBm GPRS 900/850: 32.5 dBm

Maximum power consumption LTE: 1,200 mA (peak); 900 mA (average)

HSPA+: 1,100 mA (peak); 800 mA (average) 1xRTT/EVDO: 1,000 mA (peak); 700 mA (average) E-GPRS: 2,800 mA (peak); 500 mA (average)

Form Factor M.2, 3042-S3 Key B

Weight 6.2 g

Dimensions 42 x 30 x 2.3 mm

(Length x Width x Thickness)

* Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and available on all products or in all countries.

HP hs3110 HSPA+ Intel® Mobile Broadband Module*

Technology/Operating bands HSPA+: 2100 (Band 1), 1900 (Band 2), 1700 (Band 4), 850 (Band 5), 900 (Band 8) MHz

E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 MHz (Band 5), 900 (Band 8) MHz

Wireless protocol standards WCDMA R99, 3GPP Release 5, 6 and 7 UMTS Specification

E-GPRS: Class B, Multi-slot class 33, coding schemes CS1 - CS4 and MSC1 - MSC9

GPS Standalone, A-GPS

GPS bands 1575.42 MHz ± 1.023 MHz

Maximum data rates HSPA+: 21.6 Mbps (Download), 5.76 Mbps (Upload)

E-GPRS: 296 kbps (Download), 236.8 kbps (Upload) GPRS: 107 kbps (Download), 85.6 kbps (Upload)

Maximum output power HSPA+: 24 dBm

E-GPRS 1800/1900: 26 dBm E-GPRS 850/900: 27 dBm GPRS 1800/1900: 30 dBm GPRS 850/900: 33 dBm

Maximum power consumption HSPA+: 1,100 mA (peak); 800 mA (average)

E-GPRS: 2,800 mA (peak); 700 mA (average)

Form Factor M.2, 3042-S3 Key B

Weight 6 g

Dimensions 1.65 x 1.18 x 0.09 in (42 x 30 x 2.3 mm)

(Length x Width x Thickness)

Intel® 802.11a/b/g/n/ac (2x2) and Bluetooth® 4.1 Combo



^{*} Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors.

Technical Specifications

Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11g

IEEE 802.11n

IEEE 802.11ac

Interoperability Wi-Fi certified

Frequency Band 802.11b/g/n

2.402 – 2.482 GHz

Note:

The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

802.11a/n

- 4.9 4.95 GHz (Japan)
- 5.15 5.25 GHz
- 5.25 5.35 GHz
- 5.47 5.725 GHz
- 5.825 5.850 GHz

Note: Indonesia no support this band)

• 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security¹

- IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only
- AES-CCMP: 128 bit in hardware
- 802.1x authentication
- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
- WPA2 certification
- IEEE 802.11i
- Cisco Certified Extensions, all versions through CCX4 and CCX



Technical Specifications

Lite

WAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power² • 802.11b: +16dBm minimum

• 802.11g: +14dBm minimum

• 802.11a: +14dBm minimum

• 802.11n HT20(2.4GHz): +14dBm minimum

802.11n HT40(2.4GHz): +12dBm minimum

• 802.11n HT20(5GHz): +14dBm minimum

802.11n HT40(5GHz): +12dBm minimum

Power Consumption Transmit: 2.0 W (max)

Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated)

Idle mode: 50 mW (WLAN unassociated)

Connect Standby: 10 mW (WLAN+BT)

Radio disabled: 5 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ 802.11b, 1Mbps: -94dBm maximum

802.11b, 11Mbps: -86dBm maximum

802.11g, 6Mbps: -88dBm maximum

802.11g, 54Mbps : -74dBm maximum

802.11a, 6Mbps: -88dBm maximum

802.11a, 54Mbps: -74dBm maximum

802.11n, MCS07: -69dBm maximum

802.11n, MCS15: -66dBm maximum



Technical Specifications

802.11ac, 1SS, MCS-0: -86dBm maximum

802.11ac, 1SS, MCS-9: -61dBm maximum

802.11ac, 2SS, MCS-0: -83dBm maximum

802.11ac, 2SS, MCS-9: -58dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230 : 2.3 x 22.0 x 30.0 mm

0r

Type 1630: 2.3 x 16.0 x 30.0 mm

Weight Type 2230 : 2.8g

0r

Type 1630 : 2g

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (–10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF; LED White – Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2 Compliant



Technical Specifications

Frequency Band 2402 to 2480 MHz

Number of Available Channels Legacy: 0~79 (1 MHz/CH)

BLE: 0~39 (2 MHz/CH)

Data Rates and Throughput Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps

BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device

with a maximum transmit power of + 4 dBm for BR and EDR.

Receiver Sensitivity

Legacy

Modulation	0.01% BER	0.001% BER
GFSK	-80 dBm	-70 dBm
π/4-DQPSK	-80 dBm	-70 dBm
8DPSK	-80 dBm	-70 dBm

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Range Legacy Up to 33 ft (10 m)

BLE Up to 99 ft (30 m)

Electrical Interface USB 2.0 compliant

Bluetooth Software Supported Microsoft Windows Bluetooth Software

Link Topology

Electrical Interface Point to Point, Multipoint Pico Nets up to 7 slaves

Bluetooth Software Supported Full support of Bluetooth Security Provisions

Security



Technical Specifications

Power Management Microsoft Windows ACPI, and USB Bus Support

Certifications Self-configurable to optimize power conservation in all operating

modes, including Standby, Hold, Park, and Sniff

Security All necessary regulatory approvals for supported countries, including:

Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Bluetooth Profiles Supported

Power Management ETS 300 328, ETS 300 826

Certifications Low Voltage Directive IEC950

UL, CSA, and CE Mark

Serial Port Profile (SPP)1

Service Discovery Application Profile (SDAP)

Dial-Up Networking (DUN)^{1,2}

Generic Object Exchange Profile (GOEP)1,2

Object Push Profile (OPP)1,2

Hard Copy Cable Replacement (HCRP)^{1,2} Personal Area Networking Profile (PAN)1,2 **Bluetooth Profiles Supported**

Human Interface Device Profile (HID)1,2

Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

Audio Video Remote Control Profile (AVRCP)

Bluetooth V4.1/V4.2 support

feature

Certifications

V4.1: ESR5/6/7 compliant

V4.2: ESR8 compliant, LE Secure Connection – Basic.

Intel® 802.11a/b/g/n (2x2) and Bluetooth® 4.0 Combo

Wireless LAN IEEE 802.11a **Standards** IEEE 802.11b

IEEE 802.11g



Technical Specifications

IEEE 802.11n

Interoperability Wi-Fi certified

Frequency Band 802.11b/g/n

• 2.402 - 2.482 GHz

Note:

The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

802.11a

- 4.9 4.95 GHz (Japan)
- 5.15 5.25 GHz
- 5.25 5.35 GHz
- 5.47 5.725 GHz
- 5.825 5.850 GHz

Note:

Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)

Antenna Structure 2 transmit; 2 receive (2x2)

Data Rates 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

Modulation Direct Sequence Spread Spectrum

CCK, BPSK, QPSK, 16-QAM, 64-QAM

• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

- AES-CCMP: 128 bit in hardware
- 802.1x authentication
- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
- WPA2 certification
- IEEE 802.11i
- Cisco Certified Extensions, all versions through CCX4 and CCX Lite



Technical Specifications

WAPI

Sub-channels Multinational support with frequency bands and channels compliant to

local regulations.

Network Architecture Ad-hoc (Peer to Peer)

Models Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between band Access Points

Output Power² • 802.11b: +16dBm minimum

• 802.11g: +14dBm minimum

• 802.11a: +14dBm minimum

802.11n HT20(2.4GHz): +13dBm minimum

802.11n HT40(2.4GHz): +13dBm minimum
 802.11n HT20(5GHz): +12dBm minimum

802.11n HT40(5GHz): +12dBm minimum

Power Consumption Transmit: 2.0 W (max)

Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated)

Idle mode: 60 mW (WLAN unassociated)

Radio disabled: 30 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ 802.11b, 1Mbps: -94dBm maximum

802.11b, 11Mbps: -86dBm maximum 802.11g, 6Mbps: -88dBm maximum 802.11g, 54Mbps: -74dBm maximum 802.11a, 6Mbps: -86dBm maximum 802.11a, 54Mbps: -72dBm maximum 802.11n, MCS07: -69dBm maximum 802.11n, MCS15: -66dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card

to support WLAN MIMO and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230 : 2.3 x 22.0 x 30.0 mm

0r



Technical Specifications

Type 1630: 2.3 x 16.0 x 30.0 mm

Weight Type 2230 : 2.8g

0r

Type 1630: 2g

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-

Non-operating condensing)

5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber - Radio OFF; LED White - Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0+EDR Wireless Technology

Bluetooth Specification 4.0+EDR Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Channels 79 (1 MHz) available channels

Data Rates and Throughput 3 Mbps data rate; throughput up to 2.17 Mbps

Synchronous Connection Oriented links up to 3, 64 kbps, voice channels

Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric or 1306.9 kbps symmetric

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device

with a maximum transmit power of +4 dBm for BR and EDR.

Receiver Sensitivity Modulation 0.01% BER 0.001% BER



Technical Specifications

GFSK	-80 dBm	-70 dBm
π/4-DQPSK	-80 dBm	-70 dBm
8DPSK	-80 dBm	-70 dBm

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Range Up to 33 ft (10 m)

Electrical Interface USB 2.0 compliant

Bluetooth Software Supported Microsoft Windows Bluetooth Software

Link Topology

Electrical Interface Point to Point, Multipoint Pico Nets up to 7 slaves

Bluetooth Software Supported Full support of Bluetooth Security Provisions

Security

Certifications

Power Management Microsoft Windows ACPI, and USB Bus Support

Power Management Self-configurable to optimize power conservation in all operating

modes, including Standby, Hold, Park, and Sniff

Security All necessary regulatory approvals for supported countries, including:

Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Bluetooth Profiles Supported

Power Management ETS 300 328, ETS 300 826

Certifications Low Voltage Directive IEC950

UL, CSA, and CE Mark

Certifications Serial Port Profile (SPP)¹

Service Discovery Application Profile (SDAP)

Bluetooth Profiles SupportedDial-Up Networking (DUN)^{1,2}

Generic Object Exchange Profile (GOEP)^{1,2}

Object Push Profile (OPP)^{1,2}
File Transfer Profile (FTP)
Synchronization Profile (SYNC)



Technical Specifications

Hard Copy Cable Replacement (HCRP)^{1,2} Personal Area Networking Profile (PAN)^{1,2} Human Interface Device Profile (HID)^{1,2}

FAX Profile (FAX)

Basic Imaging Profile (BIP)² Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

Bluetooth V4.1/V4.2 support feature

V4.1: ESR5/6/7 compliant

V4.2: ESR8 compliant, LE Secure Connection – Basic.

Broadcom 802.11a/b/g/n (2x2) and Bluetooth® 4.0 Combo

Wireless LAN IEEE 802.11a
Standards IEEE 802.11b
IEEE 802.11g
IEEE 802.11n

Interoperability Wi-Fi certified

Frequency Band 802.11b/g/n

• 2.402 – 2.482 GHz

Note:

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802.11a



Technical Specifications

- 4.9 4.95 GHz (Japan)
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- 5.25 5.35 GHz
- 5.47 5.725 GHz
- 5.825 5.850 GHz

Note:

Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)

Antenna Structure 2 transmit; 2 receive (2x2)

Data Rates 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

Modulation Direct Sequence Spread Spectrum

CCK, BPSK, QPSK, 16-QAM, 64-QAM

• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g

mode only

AES-CCMP: 128 bit in hardware

802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

IEEE 802.11i

Cisco Certified Extensions, all versions through CCX4 and CCX

Lite

WAPI

Sub-channels Multinational support with frequency bands and channels compliant to

local regulations.

Network Architecture Ad-hoc (Peer to Peer)

Models Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between band Access Points

Output Power² • 802.11b: +16dBm minimum

• 802.11g: +14dBm minimum

802.11a: +14dBm minimum

• 802.11n HT20(2.4GHz): +13dBm minimum

802.11n HT40(2.4GHz): +13dBm minimum
 802.11n HT20(5GHz): +12dBm minimum

802.11n HT40(5GHz): +12dBm minimum

Power Consumption Transmit: 2.0 W (max)



Technical Specifications

Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated)

Idle mode: 60 mW (WLAN unassociated)

Radio disabled: 30 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ 802.11b, 1Mbps: -94dBm maximum

802.11b, 11Mbps: -86dBm maximum 802.11g, 6Mbps: -88dBm maximum 802.11g, 54Mbps: -74dBm maximum 802.11a, 6Mbps: -86dBm maximum 802.11a, 54Mbps: -72dBm maximum 802.11n, MCS07: -69dBm maximum 802.11n, MCS15: -66dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card

to support WLAN MIMO and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230 : 2.3 x 22.0 x 30.0 mm

0r

Type 1630: 2.3 x 16.0 x 30.0 mm

Weight Type 2230 : 2.8g

0r

Type 1630: 2g

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-

Non-operating condensing)

5% to 95% (non-condensing)



Technical Specifications

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber - Radio OFF; LED White - Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0+EDR Wireless Technology

Bluetooth Specification 4.0+EDR Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Channels 79 (1 MHz) available channels

Data Rates and Throughput 3 Mbps data rate; throughput up to 2.17 Mbps

Synchronous Connection Oriented links up to 3, 64 kbps, voice channels

Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric or 1306.9 kbps symmetric

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device

with a maximum transmit power of +4 dBm for BR and EDR.

Receiver Sensitivity

Modulation	0.01% BER	0.001% BER
GFSK	-80 dBm	-70 dBm
π/4-DQPSK	-80 dBm	-70 dBm
8DPSK	-80 dBm	-70 dBm

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Range Up to 33 ft (10 m)

Electrical Interface USB 2.0 compliant

Bluetooth Software Supported Microsoft Windows Bluetooth Software



Technical Specifications

Link Topology

Electrical Interface Point to Point, Multipoint Pico Nets up to 7 slaves

Bluetooth Software Supported Full support of Bluetooth Security Provisions

Security

Certifications

Power Management Microsoft Windows ACPI, and USB Bus Support

Power Management Self-configurable to optimize power conservation in all operating

modes, including Standby, Hold, Park, and Sniff

Security All necessary regulatory approvals for supported countries, including:

Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Bluetooth Profiles Supported

Power Management ETS 300 328, ETS 300 826

Certifications Low Voltage Directive IEC950

UL, CSA, and CE Mark

Serial Port Profile (SPP)1

Service Discovery Application Profile (SDAP)

Dial-Up Networking (DUN)^{1,2}

Generic Object Exchange Profile (GOEP)^{1,2}

Certifications

Object Push Profile (OPP)^{1,2}

File Transfer Profile (FTP)

Bluetooth Profiles Supported Synchronization Profile (SYNC)

Hard Copy Cable Replacement (HCRP)^{1,2} Personal Area Networking Profile (PAN)^{1,2} Human Interface Device Profile (HID)^{1,2}

FAX Profile (FAX)

Basic Imaging Profile (BIP)² Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

Broadcom 802.11b/g/n (1x1) WiFi and Bluetooth® 4.0 Combo

Wireless LAN Standards IEEE 802.11b



Technical Specifications

IEEE 802.11g

IEEE 802.11n

Interoperability Wi-Fi certified

Frequency Band 802.11b/g/n

2.402 – 2.482 GHz

Note:

The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of

transmitting must fully comply with requirements of 15.247 or

otherwise disable those channels.

Data Rates 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: MCS 0 ~ MCS 07, (20MHz)
Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM,

Security¹

Modulation

 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

• AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

IEEE 802.11i

• Cisco Certified Extensions, all versions through CCX4 and CCX Lite

WAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power²

802.11b: +16dBm minimum

802.11g:+14dBm minimum

• 802.11n HT20(2.4GHz): +13dBm minimum

• 802.11n HT40(2.4GHz): +13dBm minimum

802.11n HT20(5GHz): +12dBm minimum

• 802.11n HT40(5GHz): +12dBm minimum

Power Consumption Transmit: 2.0 W (max)

Receive: 1.6 W (max)



Technical Specifications

Idle mode (PSP): 180 mW (WLAN Associated)
Idle mode: 60 mW (WLAN unassociated)

Radio disabled: 30 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ 802.11b, 1Mbps: -94dBm maximum

802.11b, 11Mbps : -86dBm maximum

802.11g, 6Mbps : -88dBm maximum

802.11g, 54Mbps: -74dBm maximum

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802.11n, MCS15: -66dBm maximum

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(Support Dual antenna or Single antenna, depend on platform

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Type 1630: 2g

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Bluetooth Software Supported Microsoft Windows Bluetooth Software



Technical Specifications

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Generic Object Exchange Profile (GOEP)1,2

Certifications

Object Push Profile (OPP)^{1,2}
File Transfer Profile (FTP)

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Realtek 802.11b/g/n (1x1) Wi-Fi

Wireless LAN Standards IEEE 802.11b



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Basic Imaging Profile (BIP)² Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

STORAGE AND DRIVES

500 GB 7200rpm Self Encrypting Drive (FIPS-140-2) (Opal 2)

 Drive Weight
 0.21 lbs (95 g)

 Capacity
 500 GB

 Height
 0.28 in (7 mm)



Technical Specifications

Width 2.75 in (69.85 mm) Interface **ATA-8, SATA 3.0**

Transfer Rate Synchronous (maximum) 600 MB/s **Seek Time** Single Track 1.5 ms (typical reads, including **Average** 12ms settling) Maximum 18mm-22ms

32GB Cache **Rotational Speed** 7200 rpm **Logical Blocks** 976,773,168

Operating Temperature 32° to 140° F (0° to 60° C) [top cover temp]

Features ATA Security; TCG Opal 2.x, FIPS, S.M.A.R.T., NCQ, Ultra DMA ,

500 GB 7200rpm **Hard Drive**

Drive Weight 0.20 lbs (92 q)-0.21 lbs (95 q)

500 GB Capacity Height 0.28 in (7 mm) Width 2.75 in (69.85 mm) Interface ATA-8. SATA 3.0

Transfer Rate Synchronous (maximum) 600 MB/s **Seek Time** Single Track 1.5ms-2.0ms (typical reads, including **Average** 11ms-13ms settlina) Maximum 18ms-22ms

Cache 32GB **Rotational Speed** 7200 rpm **Logical Blocks** 976,773,168

32° to 140° F (0° to 60° C) [case temp] **Operating Temperature**

500GB

Features ATA Security

500 GB 7200rpm Self-Encrypting Drive (Opal 2)

Drive Weight 0.21 lbs (95 g) Capacity

Height 0.28 in (7 mm) Width 2.75 in (69.85 mm) Interface **ATA-8, SATA 3.0**

Transfer Rate Synchronous (maximum) 600 MB/s **Seek Time** Single Track 1.5ms (typical reads, including Average 12ms settling) Maximum 18ms-22ms

Cache 32GB Rotational Speed 7200rpm **Logical Blocks** 976,773,168

Operating Temperature 32° to 140° F (0° to 60° C) [top cover temp]

Features ATA Security; TCG Opal 2.x, S.M.A.R.T., NCQ, Ultra DMA



Technical Specifications

1 TB 5400rpm Hard Drive Drive Weight 0.21 lbs (94 g)- 0.21 lbs (99 g)

Capacity 1TB

 Height
 0.28 in (7.2 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Transfer RateSynchronous (maximum)600 MB/sSeek TimeSingle Track2ms(typical reads, includingAverage12ms-13ms

Maximum

18ms-23ms

settling)

Cache Up to 32GB
Rotational Speed 5400rpm
Logical Blocks 1,953,525,168

Operating Temperature 32° to 140° F (0° to 60° C) [case temp]

Features S.M.A.R.T., NCQ, Ultra DMA

500 GB Hybrid, 8 GB cache **Drive Weight** 0.21 lb (95 g) **Capacity** 500 GB

 Height
 0.276 in (7 mm)

 Width
 2.76 in (70.1 mm)

Interface ATA-8, SATA 2.6, 6.0 Gb/s, NCQ

Transfer Rate Synchronous (maximum) 600 MB/s (Drive Capability)

Seek TimeSingle Track2 ms(typical reads, including
settling)Average12 msMaximumNIL ms

Cache64GBRotational Speed5400 rpmLogical Blocks976,773,168

Operating Temperature 32° to 140° F (0° to 60° C) [case temp]

Features ATA Security

128 GB M2 2280 SATA-3

TLC

Solid State Drive

Drive Weight 0.019 lb (8.5 g)-0.022 lb (10 g)

Capacity 128 GB

Height 0.09 in (2.23 mm)- 0.14 in (3.58 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

Performance Maximum Sequential Read Maximum Sequential Write

Up to 540 MB/s Up to 300 MB/s

Logical Blocks 250,069,680

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]



Technical Specifications

Features ATA Security, DIPM; TRIM; DEVSLP

180 GB M2 2280 SATA-3

MLC

Solid State Drive

Drive Weight 0.022 lb (<10 g)

Capacity 180 GB

 Height
 0.09 in (2.23 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

Performance Maximum Sequential Read Maximum Sequential Write

Up to 540 MB/s (Compressible UP to 490 MB/s (Compressible

Performance) Performance)

Logical Blocks 351,651,888

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security, DIPM; TRIM; DEVSLP

180 GB M2 2280 SATA-3 Self-Encrypting Drive (Opal 2) MLC Solid State

Drive

Drive Weight 0.022 lb (<10 g)

Capacity 180GB

 Height
 0.09 in (2.23 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

Performance Maximum Sequential Maximum Sequential Write

Read

Up to 540 MB/s UP to 490 MB/s (Compressible Performance)

(Compressible Performance) 351,651,888

Logical Blocks 3!

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security, TCG OPAL 2.x, DIPM; TRIM; DEVSLP

240 GB SATA-3 MLC Solid Drive Weight

State Drive

Drive Weight 0.02 lb (10 g) **Capacity** 240 GB

 Height
 0.14 in (3.58 mm)

 Width
 0.87 in (22 mm)

 Interface
 ACS-3, SATA 3.2

Performance Maximum Sequential Maximum Sequential Write

Read

Logical Blocks 468,862,128

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security, DIPM; TRIM; DEVSLP

256 GB 2280 SATA-3 TLC Drive Weight Solid State Drive Capacity

Drive Weight 0.019 lb (8.5 g)- 0.022 lb (10 g)

Capacity 256GB

Height 0.09 in (2.3 mm)- 0.14 in (3.58 mm)



Technical Specifications

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

Performance Maximum Sequential Maximum Sequential Write

Read

Up to 540 MB/s Up to 455 MB/s

Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp] **Features** ATA Security, DIPM; TRIM; DEVSLP

256 GB PCIe-3x4 NVMe

Solid State Drive

Drive Weight 0.02 lb (10 g) **Capacity** 256 GB

Height0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen3X4

Performance Maximum Sequential Maximum Sequential Write

Read

Up to 2,260 MB/s UP to 1,260 MB/s

Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security, TRIM; L1.2

256 GB M2 2280 SATA-3 Drive Weight 0.02 lb (10 g)
Self-Encrypting Drive Capacity 256 GB

(Opal 2) MLC Solid

State Drive

Height 256 GB 0.14 in (3.58 mm)- 0.09 in (2.23 mm)

Width 0.87 in (22 mm)
Interface ATA-8, SATA 3.0

Performance Maximum Sequential Maximum Sequential Write

Read

Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; TCG Opal 2.0, DIPM; TRIM; DEVSLP

512 GB M2 2280 TLC Solid State Drive **Drive Weight** 0.019 lb (8.5 g)- 0.02 lb (10 g) **Capacity** 512 GB

Height 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

Performance Maximum Sequential Maximum Sequential Write

Read

Up to 540 MB/s UP to 500 MB/s

Logical Blocks 1,000,215,216

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp] **Features** ATA Security, DIPM; TRIM; DEVSLP



Technical Specifications

512 GB M2 2280 SATA-3 Drive Weight 0.019 lb (8.5 g)- 0.02 lb (10 g)

Self-Encrypting Drive Capacity (Opal 2) MLC Solid Height State Drive Width

 Capacity
 512 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

Performance Maximum Sequential Maximum Sequential Write

Read

Up to 540 MB/s UP to 460 MB/s

Logical Blocks 1,000,215,216

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp] **Features** ATA Security, DIPM; TRIM; DEVSLP; TCG Opal 2.0

ENVIRONMENTAL

HP ProBook 640 G2 Notebook PC

Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- EPEAT <Gold> registered in the United States. See http://www.epeat.net for registration status in your country.

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".

Energy Consumption (in accordance with US ENERGY STAR® test method)

method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation (Sort idle)	7.17 W	7.43 W	7.16 W
Normal Operation (Long idle)	4.76 W	5.21 W	4.95 W
Sleep	0.8 W	0.91 W	0.79 W
Off	0.39 W	0.49 W	0.38 W



Technical Specifications

Note:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation (Short idle)	25 BTU/hr	25 BTU/hr	24 BTU/hr
Normal Operation (Long idle)	16 BTU/hr	18 BTU/hr	17 BTU/hr
Sleep	3 BTU/hr	3 BTU/hr	3 BTU/hr
Off	1 BTU/hr	2 BTU/hr	1 BTU/hr

*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (L _{WAd} , bels)	Sound Pressure (L _{pAm} , decibels)
Typically Configured — Idle	3.1	24
Fixed Disk – Random writes	3.2	24

Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 3 USB ports
- 1 PC card slot (type I/II)
- 1 ExpressCard/54 slot
- 1 IEEE 1394 Port
- 2 SODIMM memory slots
- · Optional expansion base docking station



Technical Specifications

- 1 multi-bay II storage port
- Interchangeable HDD

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain: Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the <Gold> level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 0.0% post-consumer recycled plastic (by wt.)
- This product is 96.0% recycle-able when properly disposed of at end of life.

Packaging Materials

External:	PAPER/Corrugated	366 g
Internal:	PLASTIC/EPE (Expanded Polyethylene)	42 g
	PLASTIC/Polyethylene low density	14.5 g
	PLASTIC/Polypropylene	3.2 g
		-

The plastic packaging material contains at least 50% recycled content. The corrugated paper packaging materials contains at least 70% recycled content.

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates



Technical Specifications

- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- · Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.



Technical Specifications

Hewlett-Packard Corporate Environmental Information For more information about HP's commitment to the environment:

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www8.hp.com/us/en/hp-

information/environment/ecolabels.html

ISO 14001 certificates:

http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755

and

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

HP ProBook 650 G2 Notebook PC

Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- EPEAT <Gold> registered in the United States. See http://www.epeat.net for registration status in your country.

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".

Energy	/ Con:	sumption
(in ac	cordance	with US
ENERG	Y STAF	R® test
matha	۵)	

method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation (Sort idle)	8.44 W	9.26 W	8.62 W
Normal Operation (Long idle)	5.69 W	5.73 W	5.61 W
Sleep	0.62 W	0.74 W	0.6 W
Off	0.41 W	0.54 W	0.4 W



Technical Specifications

Note:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation (Short idle)	29 BTU/hr	32 BTU/hr	29 BTU/hr
Normal Operation (Long idle)	19 BTU/hr	20 BTU/hr	19 BTU/hr
Sleep	2 BTU/hr	3 BTU/hr	2 BTU/hr
Off	1 BTU/hr	2 BTU/hr	1 BTU/hr

*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (L _{WAd} , bels)	Sound Pressure (L _{pAm} , decibels)
Typically Configured — Idle	3.0	19
Fixed Disk – Random writes	3.0	20

Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 3 USB ports
- 1 PC card slot (type I/II)
- 1 ExpressCard/54 slot
- 1 IEEE 1394 Port
- 2 SODIMM memory slots
- · Optional expansion base docking station



Technical Specifications

- 1 multi-bay II storage port
- Interchangeable HDD

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain: Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the <gold> level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 0% post-consumer recycled plastic (by wt.)
- This product is 96.5% recycle-able when properly disposed of at end of life.

Packaging Materials

External:	PAPER/Paper	360.2g		
Internal: PLASTIC/EPE (Expanded Polyethylene)				
	PLASTIC/Polyethylene low density	13.6 g		
The plastic packaging material contains at least 50% recycled content.				
The corrugated paper packaging materials contains at least 70% recycled				

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/qlobalcitizenship/environment/pdf/qse.pdf):

Asbestos

content.

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http://www8.hp.com/us/en/hp-

information/environment/ecolabels.html

ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU _Product_Design_ISO_14K_Certificate.pdf

and

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

COUNTRY OF ORIGIN

China



Options and Accessories (Sold separately and availability may vary by country.)

Туре	Description	Part Number
Docking	HP 3001pr USB 3.0 Port Replicator	F3S42AA
	HP 3005pr USB 3.0 Port Replicator	H1L08AA#xxx
	HP Display and Notebook Stand II	E8G00AA#xxx
	Universal Port Replicator	E6D70AA#xxx
	HP UltraSlim Docking Station	D9Y32AA#xxx
Input/Output/Audio	HP USB Travel Mouse	G1K28AA#xxx
	HP Ultrathin Wireless Mouse SE	L9V77AA
	HP Ultrathin Wireless Mouse	L9V78AA
	HP Stereo USB Headset	T1A67AA
	DisplayPort to HDMI Adapter	F3W43AA
	DisplayPort to DVI Adapter	F7W96AA
Power	HP 45W Smart AC Adapter (4.5mm)	H6Y88AA#xxx
	HP 65W Smart AC Adapter	H6Y89AA#xxx
Storage - External Storage	HP USB External DVDRW Drive	F2B56AA
Security	HP UltraSlim Keyed Cable Lock	H4D73AA
	HP USB Smart Card Reader	F6V67AA
	HP Docking Station Cable Lock	AU656AA#XXX
Display	HP ProDisplay P232	K7X31AA
	HP ProDisplay P222va	K7X30AA
	HP ProDisplay P222c	L4J08AA



Summary of Changes

Date of change:	Version History:		Description of change:
January 21, 2016	Version 1 to 2	Added	Environmental info
January 29, 2016	Version 2 to 3	Updated	MIL STD testing
			Battery life and stand by time
			Discrete graphics for HP ProBook 650 G2
			Display descriptions with CG and nits
February 12, 2016	Version 3 to 4	Changed	Overview statement to
			Three USB 3.0 ports for fast data transfer from devices: 1
			standard, 1 charging, and one USB-C™ charging port
February 18, 2016	Version 4 to 5	Added	Security specs to the back for Finger Print Reader and Smart Card
			Reader
February 18, 2016 Version 5 to 6	Version 5 to 6	Updated	Intel® 802.11a/b/g/n/ac specs to 4.0
		Added	Specs for panels
March 3, 2016 Version 6 to 7	Added	Battery recharge times, new broadband module: Broadcom	
			802.11a/b/g/n (2x2) and Bluetooth® 4.0 Combo
		Removed	Intel® 802.11a/b/g/n (2x2) and Bluetooth® 4.2 Combo
March 31, 2016	Version 7 to 8	Changed	TPM upgrade footnote
May 5, 2016	Version 8 to 9	Changed	TPM 1.2 to 2.0
June 8, 2016	Version 9 to 10	Added	Storage and drives section
June 30, 2016	Version 10 to 11	Added	Numeric pad callout to 650 G2
August 8, 2016	Version 11 to 12	Changed	Processors and chipset section

